

SOLC-150-02-F-Q-A

SOLC-135-02-L-Q-LC

SOLC-125-02-L-Q-LC

SOLC SERIES

(1.27 mm) .050"

QUAD ROW SMT SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SOLC

Insulator Material: Black Liquid Crystal Polymer Contact Material: Phosphor Bronze

Plating: Au over 50 μ" (1.27 μm) Ni Current Rating: 2.4 A per pin (6 adjacent pins powered) Operating Temp Range: -55 °C to +125 °C

-55 °C to +125 °C Insertion Depth: (1.68 mm) .066" to (3.61 mm) .142" with (0.38 mm) .015" wipe

Normal Force: 75 grams (0.74 N) average Max Cycles:

100+ RoHS Compliant:

PROCESSING

Lead-Free Solderable:

Yes
SMT Lead Coplanarity:
(0.10 mm) .004" max (05-35)
(0.15 mm) .006" max (40-50)*
*(.004" stencil solution
may be available; contact
IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



OTHER SOLUTIONS

 For Micro Rugged, see the MOLC/FOLC pages located in the Tiger Eye™ section.

ALSO AVAILABLE (MOQ Required)

- Other sizes
- Other platings

Note:

Some sizes, styles and options are non-standard, non-returnable.

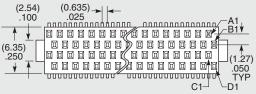
Mates with: TOLC (1.27 mm) .050" Drop-in replacement for FOLC/MOLC when mated with TOLC

SOLC = 1 NO. PINS PER ROW = 02 PLATING OPTION OPTION

Surface

mount

05, 10, 15, 20, 25, 30, 35, 40, 45, 50 (Standard sizes)



→ F = Gold flash on contact, Gold flash on tail Optional

locking clips

and alignment pins

= Alignment Pin (N/A with -LC)

<u>–LC</u>

= Locking Clip

(N/A with -A)

(Manual placement

required)

= (7.00 mm) .276" DIA

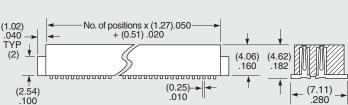
Polyimide film Pick & Place Pad

−P

= Pick & Place Pad

−TR = Tap<u>e & Reel</u>

— **L** = 10 μ" (0.25 μm) Gold on contact, Gold flash on tail





(4.93) .194 —P OPTION

-LC OPTION